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**Special Issue on CEM and Multiphysics  
Simulation for Electromagnetic Materials,  
Structures and Devices**

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**July 2019**

**Vol. 34 No. 7**

**ISSN 1054-4887**

The ACES Journal is abstracted in INSPEC, in Engineering Index, DTIC, Science Citation Index Expanded, the Research Alert, and to Current Contents/Engineering, Computing & Technology.

The illustrations on the front cover have been obtained from the research groups at the Department of Electrical Engineering, The University of Mississippi.

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